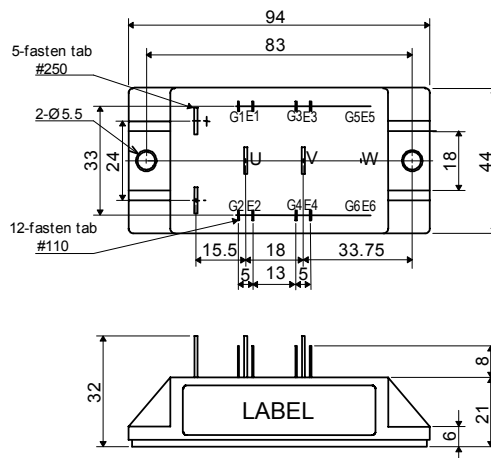
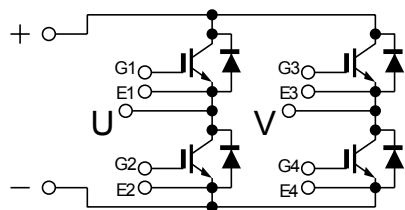


I G B T Module-H Bridge

5 0 A, 6 0 0 V

P B M B 5 0 E 6

□ 回路図 : *CIRCUIT*□ 外形寸法図 : *OUTLINE DRAWING*

Dimension: [mm]

□ 最大定格 : *MAXIMUM RATINGS* ($T_c = 25^\circ\text{C}$)

Item		Symbol	Rated Value	Unit
コレクタ・エミッタ間電圧 Collector-Emitter Voltage		V_{CES}	600	V
ゲート・エミッタ間電圧 Gate-Emitter Voltage		V_{GES}	± 20	V
コレクタ電流 Collector Current	DC	I_C	50	A
	1ms	I_{CP}	100	
コレクタ損失 Collector Power Dissipation		P_C	250	W
接合温度 Junction Temperature Range		T_j	$-40 \sim +150$	$^\circ\text{C}$
保存温度 Storage Temperature Range		T_{stg}	$-40 \sim +125$	$^\circ\text{C}$
絶縁耐圧(Terminal to Base AC, 1 minute) Isolation Voltage		V_{ISO}	2,500	V (RMS)
締め付けトルク Mounting Torque	Module Base to Heatsink	F_{tor}	2 (20.4)	N·m (kgf·cm)

□ 電気的特性 : *ELECTRICAL CHARACTERISTICS* ($T_c = 25^\circ\text{C}$)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
コレクタ遮断電流 Collector-Emitter Cut-Off Current		I_{CES}	$V_{CE} = 600V, V_{GE} = 0V$	—	—	1.0	mA
ゲート漏れ電流 Gate-Emitter Leakage Current		I_{GES}	$V_{GE} = \pm 20V, V_{CE} = 0V$	—	—	1.0	μA
コレクタ・エミッタ間飽和電圧 Collector-Emitter Saturation Voltage		$V_{CE(sat)}$	$I_C = 50A, V_{GE} = 15V$	—	2.1	2.6	V
ゲートしきい値電圧 Gate-Emitter Threshold Voltage		$V_{GE(th)}$	$V_{CE} = 5V, I_C = 50mA$	4.0	—	8.0	V
入力容量 Input Capacitance		C_{ies}	$V_{CE} = 10V, V_{GE} = 0V, f = 1MHz$	—	2,500	—	pF
スイッチング時間 Switching Time	上昇時間 Rise Time	t_r	$V_{CC} = 300V$ $R_L = 6.0\Omega$ $R_G = 20.0\Omega$ $V_{GE} = \pm 15V$	—	0.15	0.30	μs
	ターンオン時間 Turn-on Time	t_{on}		—	0.25	0.40	
	下降時間 Fall Time	t_f		—	0.10	0.35	
	ターンオフ時間 Turn-off Time	t_{off}		—	0.35	0.70	

□ フリーホイーリングダイオードの特性 : *FREE WHEELING DIODE RATINGS & CHARACTERISTICS* ($T_c = 25^\circ\text{C}$)

I t e m		S y m b o l	R a t e d V a l u e			U n i t
順電流 Forward Current	DC	I_F	50			A
	1 m s	I_{FM}	100			

C h a r a c t e r i s t i c		S y m b o l	T e s t C o n d i t i o n	M i n .	T y p .	M a x .	U n i t
順電圧 Peak Forward Voltage		V_F	$I_F = 50A, V_{GE} = 0V$	—	1.9	2.4	V
逆回復時間 Reverse Recovery Time		t_{rr}	$I_F = 50A, V_{GE} = -10V$ $di/dt = 100A/\mu s$	—	0.15	0.25	μs

□ 熱的特性 : *THERMAL CHARACTERISTICS*

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
熱抵抗 Thermal Impedance	IGBT	$R_{th(j-c)}$	Junction to Case (T_c 測定点チップ直下)	—	—	0.50	$^\circ\text{C}/\text{W}$
	Diode			—	—	1.10	

P B M B 5 0 E 6

Fig.1- Output Characteristics (Typical)

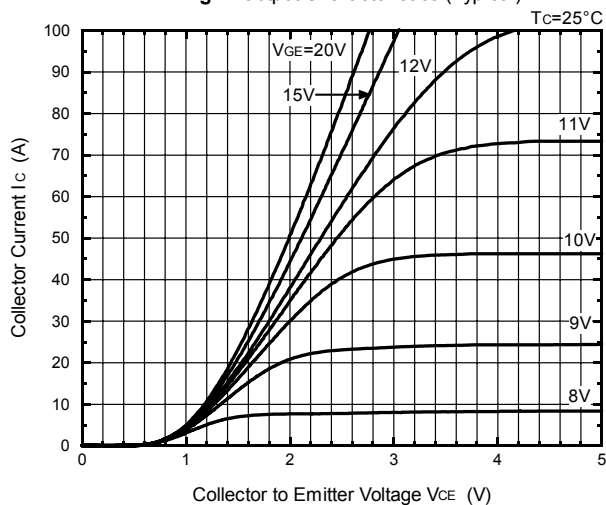


Fig.2- Output Characteristics (Typical)

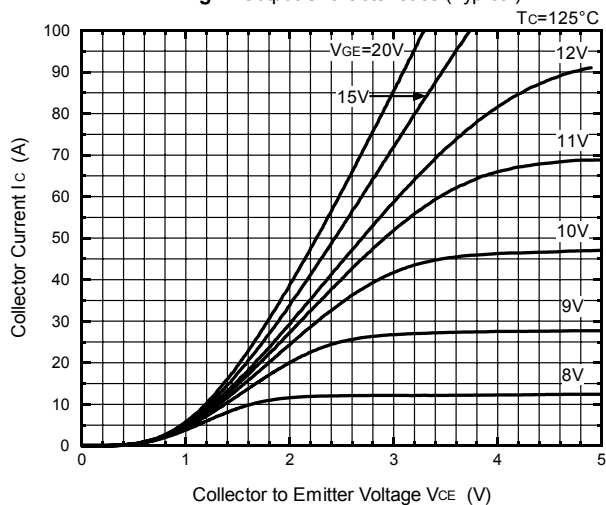


Fig.3- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)

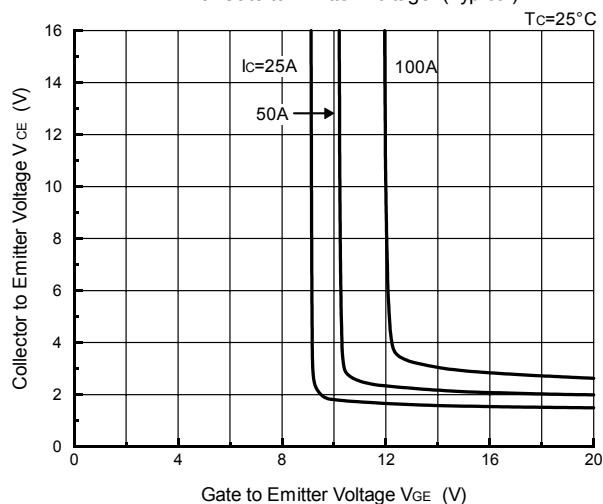


Fig.4- Collector to Emitter On Voltage vs. Gate to Emitter Voltage (Typical)

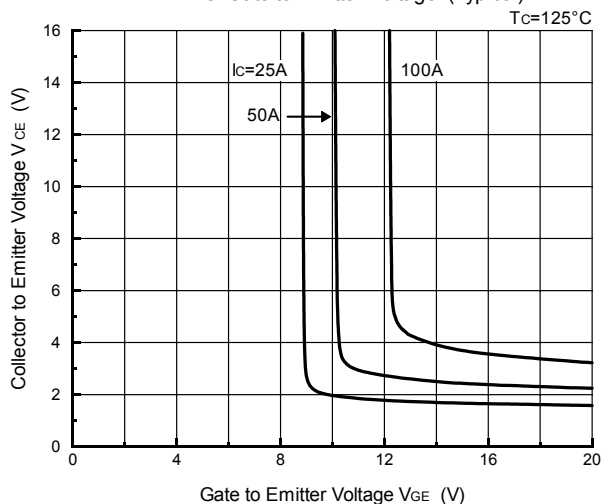


Fig.5- Gate Charge vs. Collector to Emitter Voltage (Typical)

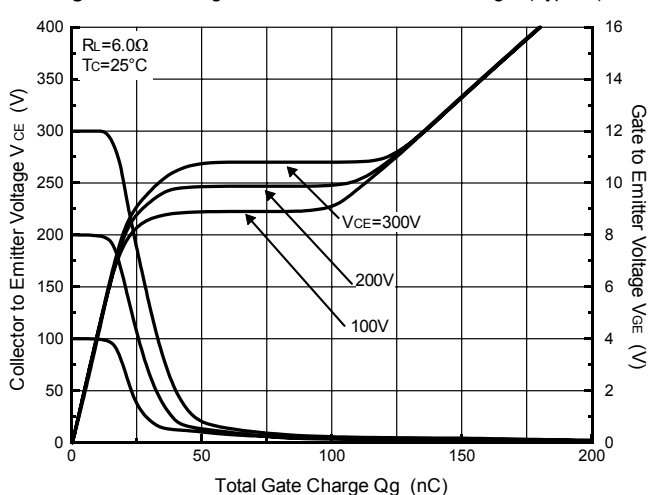
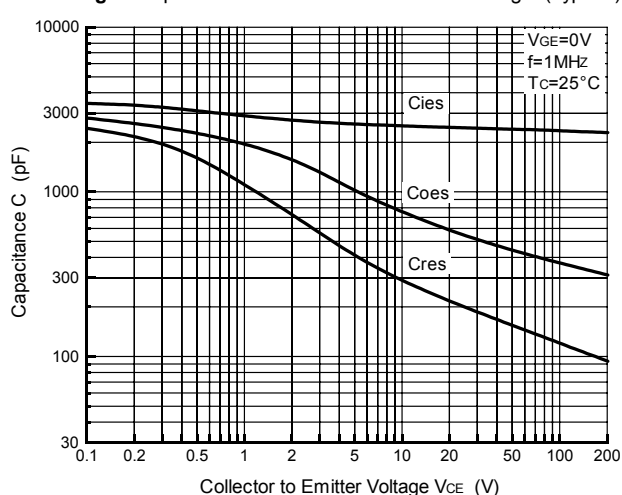


Fig.6- Capacitance vs. Collector to Emitter Voltage (Typical)



P B M B 5 0 E 6

Fig.7- Collector Current vs. Switching Time (Typical)

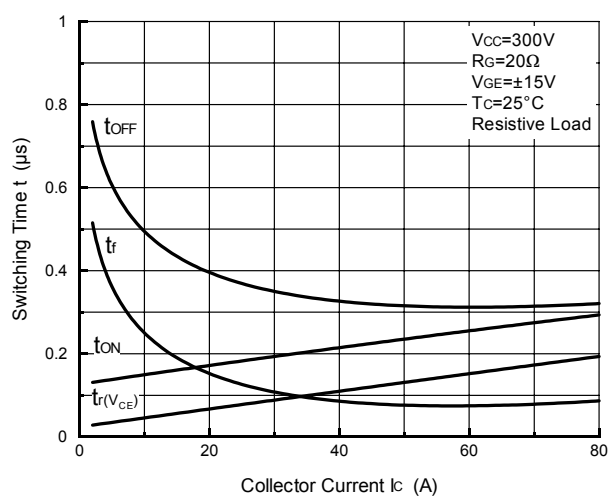


Fig.8- Series Gate Impedance vs. Switching Time (Typical)

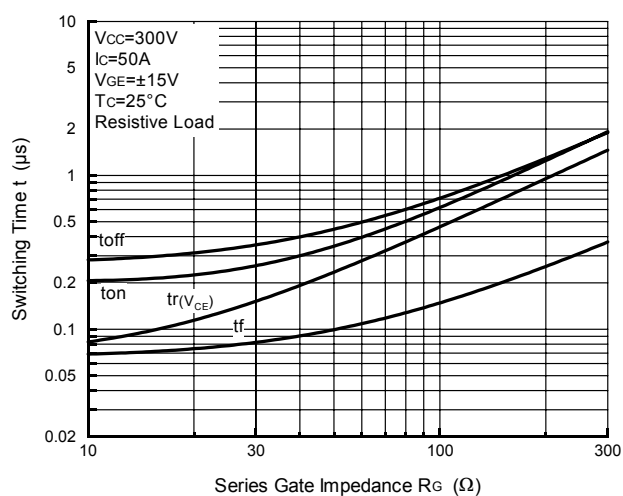


Fig.9- Collector Current vs. Switching Time

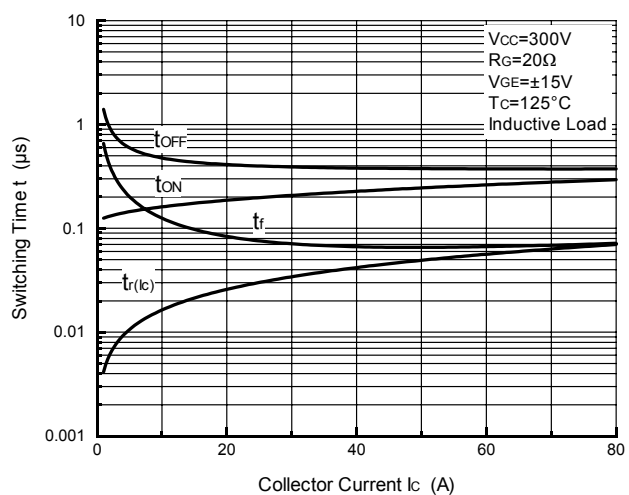


Fig.10- Series Gate Impedance vs. Switching Time

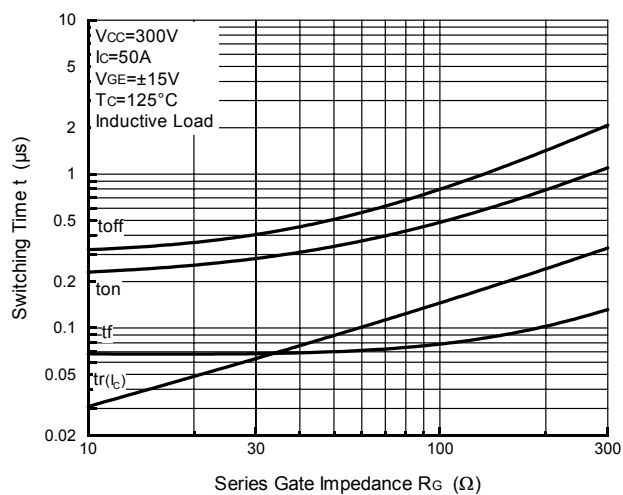


Fig.11- Collector Current vs. Switching Loss

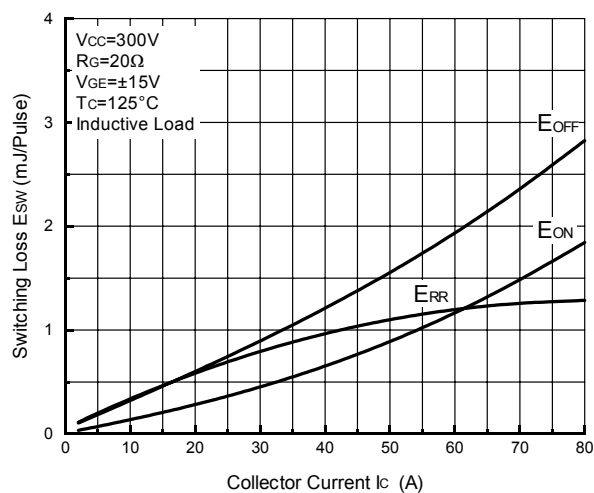
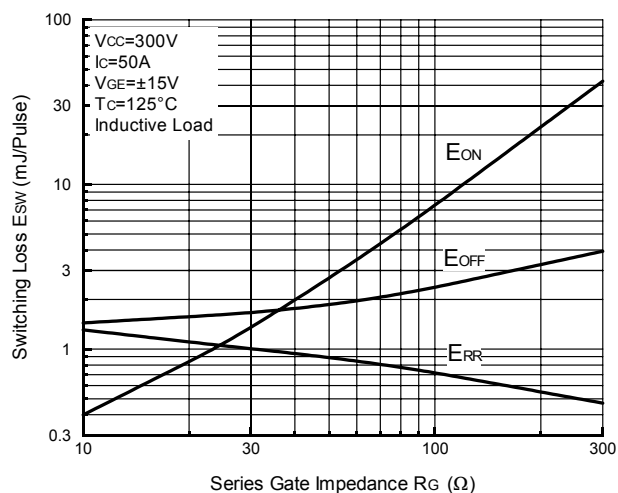
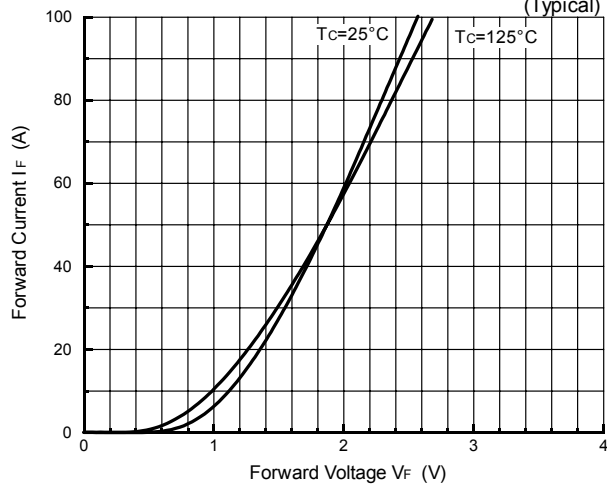
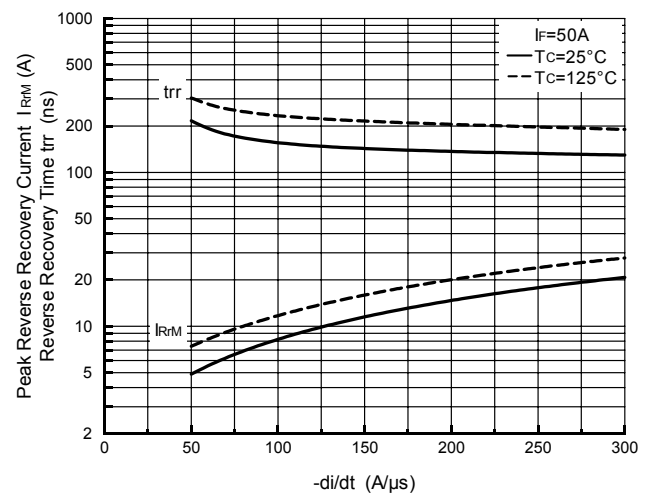
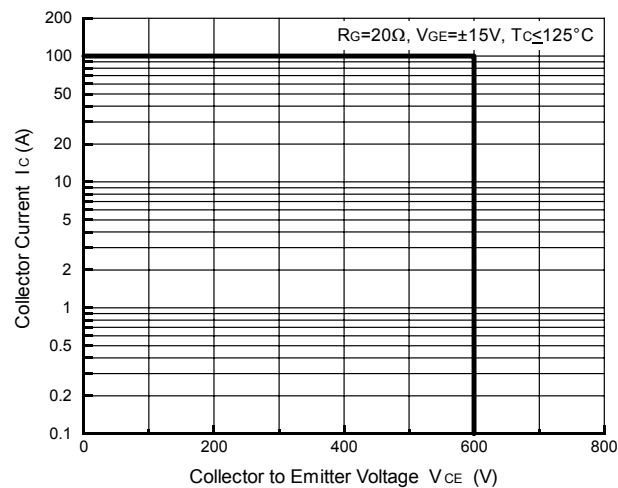


Fig.12- Series Gate Impedance vs. Switching Loss



P B M B 5 0 E 6

Fig.13- Forward Characteristics of Free Wheeling Diode (Typical)**Fig.14- Reverse Recovery Characteristics (Typical)****Fig.15- Reverse Bias Safe Operating Area****Fig.16- Transient Thermal Impedance**